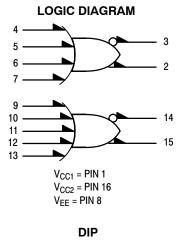
# Dual 4-5-Input OR/NOR Gate

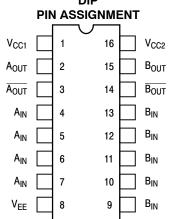
## Description

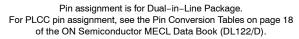
The MC10H209 is a Dual 4–5–input OR/NOR gate. This MECL part is a functional/pinout duplication of the MECL III part MC1688.

## Features

- Propagation Delay Average, 0.75 ns Typical
- Power Dissipation 125 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K<sup>TM</sup> Compatible
- Pb-Free Packages are Available\*



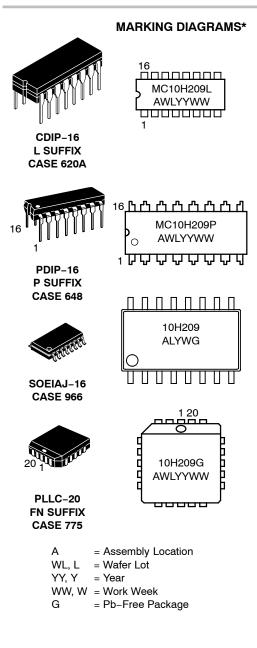




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\*For additional marking information, refer to Application Note AND8002/D.

#### ORDERING INFORMATION See detailed ordering and shipping information in the package

dimensions section on page 3 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Semiconductor Components Industries, LLC, 2006 February, 2006 – Rev. 7

#### Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
$V_{EE}$	Power Supply (V <sub>CC</sub> = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current – Continuous – Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range – Plastic – Ceramic	−55 to +150 −55 to +165	°C ℃

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

#### Table 2. ELECTRICAL CHARACTERISTICS ( $V_{EE} = -5.2 \text{ V} \pm 5\%$ ) (Note 1)

		<b>0</b> °		<b>25</b> °		<b>75</b> °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
١ <sub>E</sub>	Power Supply Current	-	-	-	30	-	-	mA
I <sub>inH</sub>	Input Current High	-	640	-	400	-	400	μΑ
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
VIL	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

1. Each MECL 10H<sup>™</sup> series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to −2.0 V.

#### Table 3. AC PARAMETERS

		0	0° 25°		<b>75</b> °			
Symbol	ol Characteristic		Max	Min	Max	Min	Мах	Unit
t <sub>pd</sub>	Propagation Delay	0.4	1.15	0.4	1.15	0.4	1.15	ns
tr	Rise Time	0.4	1.5	0.4	1.5	0.4	1.6	ns
t <sub>f</sub>	Fall Time	0.4	1.5	0.4	1.5	0.4	1.6	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC10H209FN	PLLC-20	46 Units / Rail
MC10H209FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H209FNR2	PLLC-20	500 / Tape & Reel
MC10H209FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H209L	CDIP-16	25 Unit / Rail
MC10H209M	SOEIAJ-16	50 Unit / Rail
MC10H209MEL	SOEIAJ-16	2000 / Tape & Reel
MC10H209MELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC10H209P	PDIP-16	25 Unit / Rail

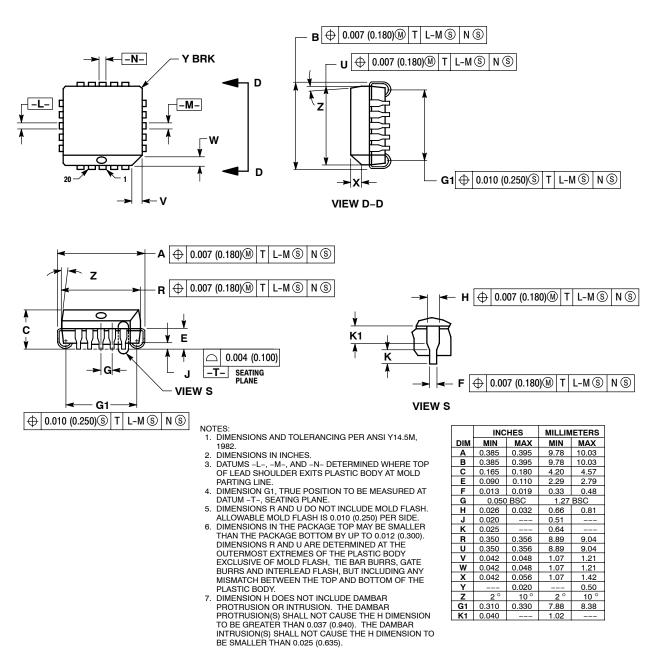
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MC10H209

#### PACKAGE DIMENSIONS



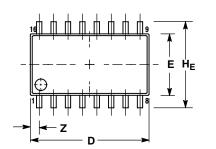
CASE 775-02 ISSUE E

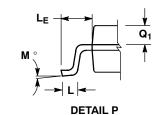


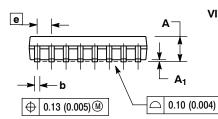
## MC10H209

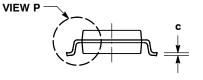
### PACKAGE DIMENSIONS

#### SOEIAJ-16 CASE 966-01 **ISSUE A**







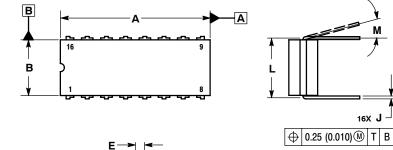


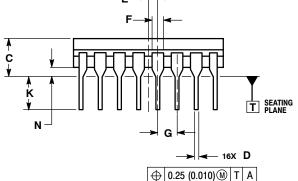
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

- NO TES:
  NO TES:
  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION ANTERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES
DIM	MIN MAX		MIN	MAX
Α		2.05		0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
C	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27	BSC	0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
Μ	0 °	10 °	0 °	10 °
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Ζ		0.78		0.031

CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620A-01 **ISSUE O** 





NOTES:

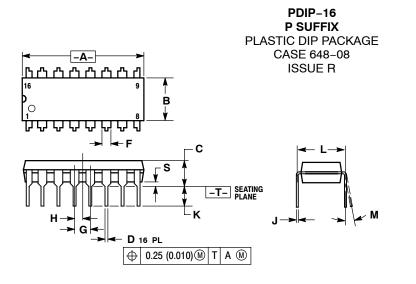
16X J

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC PODY
- BODY. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10. 5

	INCHES MILLIMETERS						
			MILLIMETERS MIN MAX				
DIM	MIN	MIN MAX		MAX			
Α	0.750	0.785	19.05	19.93			
В	0.240	0.295	6.10	7.49			
С	0.200			5.08			
D	0.015 0.020		0.39	0.50			
Е	0.050 BSC		1.27 BSC				
F	0.055	0.065	1.40	1.65			
G	0.100	BSC	2.54 BSC				
Н	0.008	0.015	0.21	0.38			
К	0.125	0.170	3.18	4.31			
L	0.300 BSC		7.62 BSC				
М	0 °	15 °	0 °	15°			
Ν	0.020	0.040	0.51	1.01			

#### MC10H209

#### PACKAGE DIMENSIONS



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

CONTROLLING DIMENSION: INCH.

DIMENSION L TO CENTER OF LEADS WHEN 3

FORMED PARALLEL DIMENSION B DOES NOT INCLUDE MOLD FLASH. ROUNDED CORNERS OPTIONAL. 5.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145 0.175		3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100 BSC		2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
Μ	0 °	10 °	0 °	10 °	
S	0.020	0.020 0.040		1.01	

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